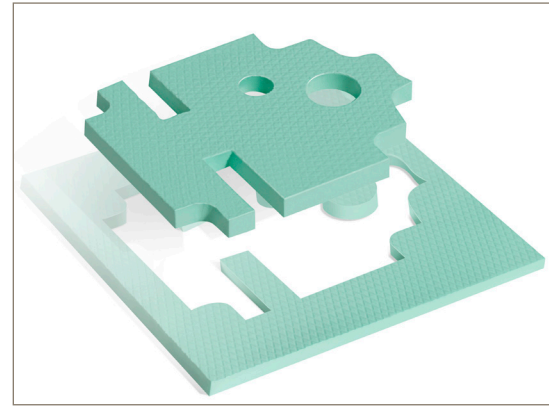


THERM-A-GAP™ PAD 60

ULTRA-SOFT, 6.0 W/m-K THERMALLY
CONDUCTIVITY GAP FILLER PAD

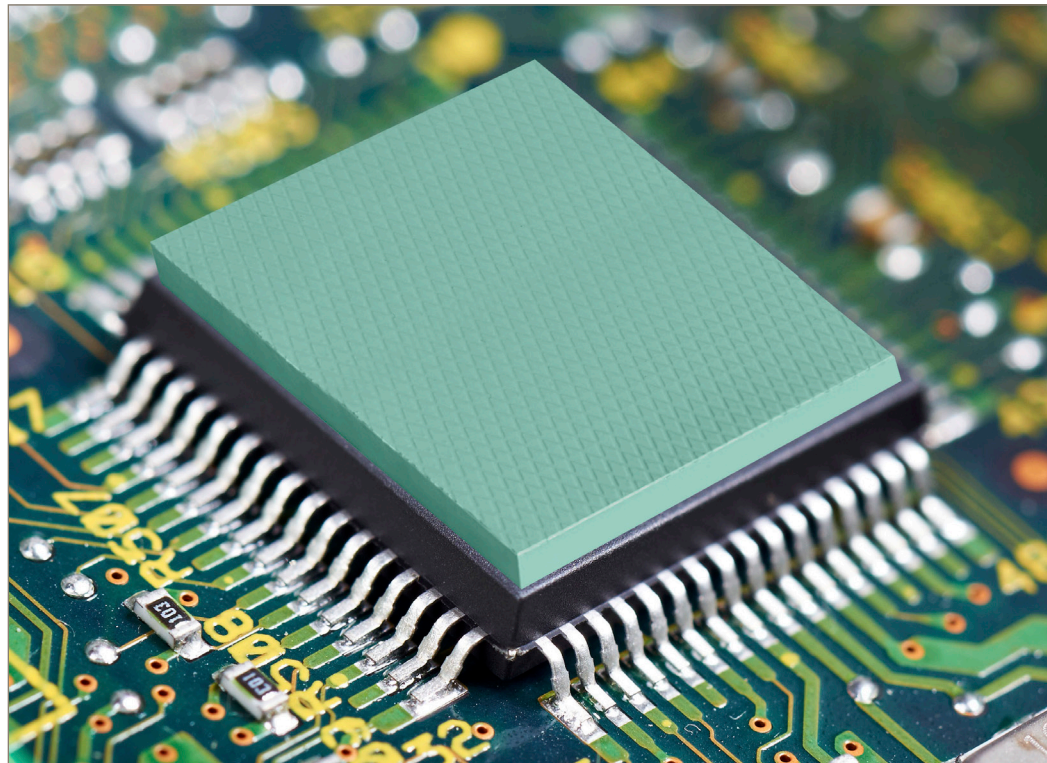


Customer Value Proposition:

Parker Chomerics THERM-A-GAP™ PAD 60 is an ultra-soft, ultra-conformable high performance thermally conductive gap filler pad with 6.0 W/m-K thermal conductivity.

THERM-A-GAP PAD 60 offers the combination of both excellent thermal conductivity and ultra-soft conformability, along with very low outgassing to provide an effective thermal interface between heat sinks and electronic devices where there are uneven surfaces, air gaps and rough surface textures may exist.

THERM-A-GAP PAD 60 is manufactured to size and facilitates easy application on the desired component.



Contact Information:

Parker Hannifin Corporation
Parker Chomerics
77 Dragon Court
Woburn, MA 01801

phone 781 935 4850
fax 781 933 4318
chomailbox@parker.com

www.parker.com/chomerics

Product Features:

- 6.0 W/m-K thermal conductivity
- Ultra low deflection force
- High thermal conductivity
- “A” version offers high strength acrylic PSA for permanent attachment
- UL recognized V-0 flammability
RoHS compliant

Typical Applications:

- 5G telecom equipment
- Smart home devices
- Automotive electronics (ECUs)
- LEDs
- Power supplies
- Desktop computers, laptops, servers
- Handheld devices
- Memory modules
- Vibration dampening

Product Information

THERM-A-GAP PAD 60

| THERM-A-GAP PAD 60 | | | |
|---------------------|--|-------------------------------------|--|
| Typical Properties† | | PAD 60 | Test Method |
| Physical | Color | Green | Visual |
| | Carrier Options: A= Aluminum foil w/ pressure sensitive adhesive None (unsupported) = No letter suffix | PAD60A PAD60 | -- |
| | Standard Thicknesses*, in. (mm) | 0.020 - 0.200 (0.50 - 5.0) | ASTM D374 |
| | Specific Gravity | 3.3 | ASTM D792 |
| | Hardness, Shore 00 | 31 | ASTM D2240 |
| | Percent Deflection @ Various Pressures** (0.100 in thick sample) @ 5 psi (34 kPa) @ 10 psi (69 kPa) @ 25 psi (172 kPa) @ 50 psi (345 kPa) | % Deflected 12 17 27 38 | ASTM C165 MOD (0.100 in "A" Carrier, 0.50 in dia. probe, 0.025 in/min rate) |
| Thermal | Operating Temperature Range, °F (°C) | -67 to 392 (-55 to 200) | Chomerics |
| | Thermal Conductivity, W/m-K | 6.7 | ASTM D5470 |
| | Thermal Impedance, °C-in ² /W (°C-cm ² /W) @ 10 psi, @ 0.04 in. (1mm) thick, "G" version | 0.2 (1.5) | ASTM D5470 |
| | Heat Capacity, J/g-K | 1 | ASTM E1269 |
| | Coefficient of Thermal Expansion, ppm/K | 150 | ASTM E831 |
| Electrical | Dielectric Strength, VAC/mil (KVAC/mm) | 127 (5.0) | ASTM D149 |
| | Volume Resistivity, ohm-cm | 10 ¹³ | ASTM D257 |
| | Dielectric Constant @ 1,000 kHz | 9.3 | ASTM D150 |
| | Dissipation Factor @ 1,000 kHz | 0.006 | Chomerics |
| Regulatory | Flammability Rating (See UL File E140244 for Details) | V-0 | UL 94 |
| | RoHS Compliant | Yes | Chomerics Certification |
| | Outgassing, % TML (% CVCM) | 0.05 (0.01) | ASTM E595 |
| | Shelf Life, months from date of shipment (PAD60A) | 36 (18) | Chomerics |
| | Storage Conditions, °F (°C) @ 50% Relative Humidity | 50 to 90 (10 to 32) | Chomerics |

† Typical properties: these are not to be construed as specifications.